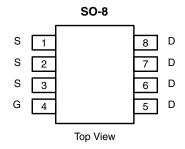




Vishay Siliconix

# N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$ Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
	0.0088 at V <sub>GS</sub> = 10 V	18.4				
100	0.0094 at V <sub>GS</sub> = 7.5 V	17.8	20.7 nC			
	0.0120 at V <sub>GS</sub> = 4.5 V	15.8				



### **Ordering Information:**

Si4190ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

### **FEATURES**

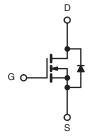
- TrenchFET® Power MOSFET
- 100 %  $R_g$  and UIS Tested
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



HALOGEN **FREE** 

### **APPLICATIONS**

- DC/DC Primary Side Switch
- Telecom/Server
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	IGS (1A = 25 C		erwise rioleu)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	100	V	
Gate-Source Voltage		$V_{GS}$	± 20	v	
	T <sub>C</sub> = 25 °C		18.4		
Continuous Drain Current /T 150 °C)	T <sub>C</sub> = 70 °C		14.6		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	13 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		10.3 <sup>b, c</sup>	Δ.	
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	70	Α	
	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	5.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C		2.7 <sup>b, c</sup>		
Single Pulse Avalanche Current	. 0.1	I <sub>AS</sub>	30		
Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		6		
Mariana Paran Piasiastian	T <sub>C</sub> = 70 °C		3.8	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	16	21	- C/VV		

### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- d. Maximum under steady state conditions is 85 °C/W.

Document Number: 63826 S12-0541-Rev. A, 12-Mar-12 For technical support, please contact: pmostechsupport@vishav.com

# Si4190ADY

## Vishay Siliconix



<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		64		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- 10 – 200 μπ		- 5.8		lilly/ C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.5		2.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Oata Wallana Busin Oamani	lana	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			1	- μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>				10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0073	0.0088		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 12 A		0.0078	0.0094		
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.0096	0.0120		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		54		S	
Dynamic <sup>b</sup>			L				
Input Capacitance	C <sub>iss</sub>			1970			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		695		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			62			
Total Octo Observe	0	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		44.4	67		
Total Gate Charge	$Q_g$	Q <sub>g</sub>		20.7	31	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		6.1			
Gate-Drain Charge	$Q_{gd}$			9.1			
Output Charge	Q <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V		56	85		
Gate Resistance	$R_g$	f = 1 MHz	0.4	1.1	2.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	30		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		11	22		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$		31	60		
Fall Time	t <sub>f</sub>			10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		34	65		
Fall Time	t <sub>f</sub>			10	20		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			5.4		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A		0.76	1.1	٧	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			42	80	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			40	80	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		19		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1		23			

### Notes:

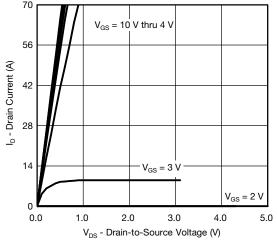
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

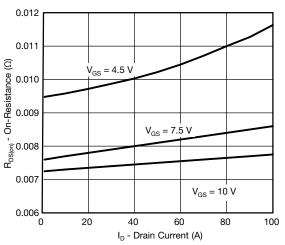


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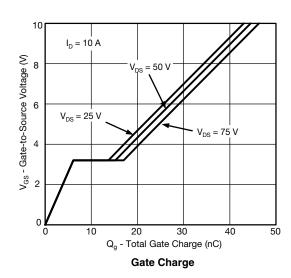
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

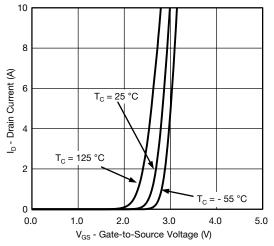


### **Output Characteristics**

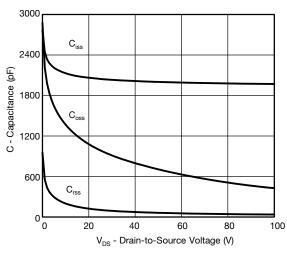


On-Resistance vs. Drain Current

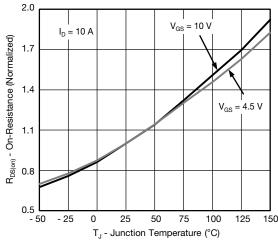




**Transfer Characteristics** 



Capacitance

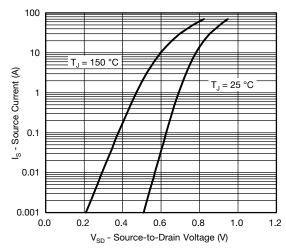


On-Resistance vs. Junction Temperature

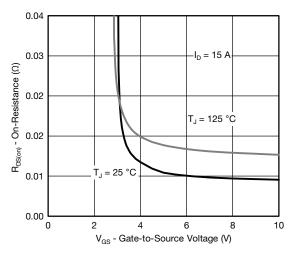
## Si4190ADY

## Vishay Siliconix

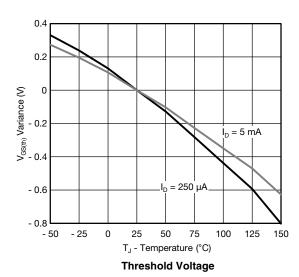
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

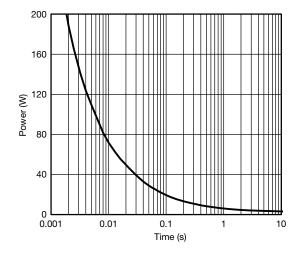


Source-Drain Diode Forward Voltage

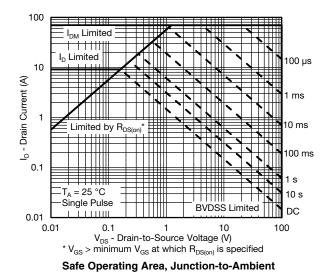


On-Resistance vs. Gate-to-Source Voltage





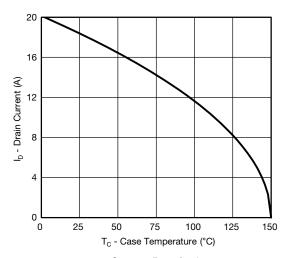
Single Pulse Power, Junction-to-Ambient



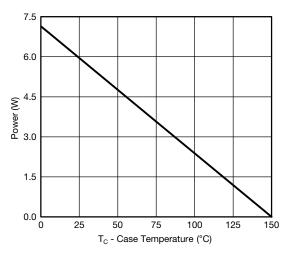


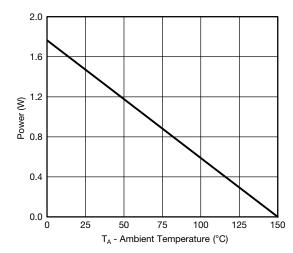
# Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



### **Current Derating\***





Power, Junction-to-Foot Power, Junction-to-Ambient

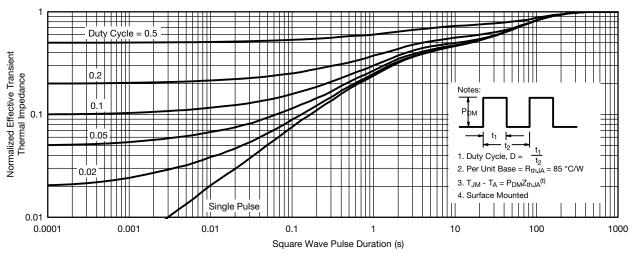
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## Si4190ADY

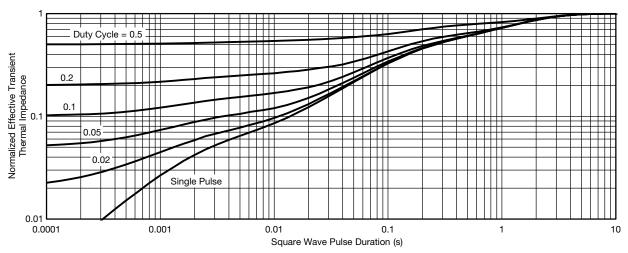
## Vishay Siliconix



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63826



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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